

Special Issue

Advances in Bioelectronics

Message from the Guest Editor

Applied Science is preparing a special issue on Advances on Bioelectronics, and we would like to invite you to write a piece on how engineering is contributing to biomedical/neuroscience. I think a forward-looking perspective on neural probes, microelectrodes, neuroprosthetics, implantable devices, and potentially other relevant techniques/applications would be informative for our readers. It would be extremely helpful to have a good sense of what people are writing and how their articles relate as we put this special issue together. I realize this is rather vague, and I'd be happy to hear your thoughts on how to refine the content if you are interested. We would need a final draft (i.e., a draft ready for peer-review) by **December 2019**. keywords

- Neural probes
- Multichannel electrodes
- Neuroprosthetics
- Implantable devices
- Optogenetics
- Wearable electronics
- Brain–Machine Interface

Guest Editor

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Deadline for manuscript submissions

closed (30 December 2019)



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About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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